Preferred Device

SWITCHMODE™ Power Rectifier

D²PAK Surface Mount Power Package

The D²PAK Power Rectifier employs the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

Features

- Pb-Free Packages are Available
- Center-Tap Configuration
- Guardring for Stress Protection
- Low Forward Voltage
- 175°C Operating Junction Temperature
- Epoxy Meets UL 94, V-0 @ 0.125 in
- Short Heatsink Tab Manufactured Not Sheared
- Similar in Size to the Industry Standard TO220 Package

Mechanical Characteristics

- Case: Epoxy, Molded, Epoxy Meets UL 94, V-0
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Device Meets MSL1 Requirements
- ESD Ratings: Machine Model, C (>400 V)

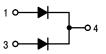
Human Body Model, 3B (>8000 V)



ON Semiconductor®

http://onsemi.com

SCHOTTKY BARRIER RECTIFIER 15 AMPERES 45 VOLTS





D²PAK CASE 418B STYLE 3

MARKING DIAGRAM



B1545 = Device Code

A = Assembly Location

Y = Year WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping [†]
MBRB1545CT	D ² PAK	50 Units/Rail
MBRB1545CTG	D ² PAK (Pb-Free)	50 Units/Rail
MBRB1545CTT4	D ² PAK	800/Tape & Reel
MBRB1545CTT4G	D ² PAK (Pb-Free)	800 Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

MAXIMUM RATINGS (Per Leg)

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	45	V
Average Rectified Forward Current (Rated V_R , $T_C = 105$ °C) Total Device	I _{F(AV)}	7.5 15	А
Peak Repetitive Forward Current, (Rated V _R , Square Wave, 20 kHz, T _C = 105°C)	I _{FRM}	15	Α
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	150	А
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I _{RRM}	1.0	Α
Storage Temperature Range	T _{stg}	-65 to +175	°C
Operating Junction Temperature (Note 1)	TJ	-65 to +175	°C
Voltage Rate of Change (Rated V _R)	dv/dt	10,000	V/μs

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS (Per Leg)

Characteristic	Symbol	Value	Unit
Thermal Resistance — Junction to Case — Junction to Ambient (Note 2)	$R_{ hetaJC} \ R_{ hetaJA}$	2.0 50	°C/W

ELECTRICAL CHARACTERISTICS (Per Leg)

Maximum Instantaneous Forward Voltage (Note 3) ($i_F = 7.5 \text{ Amps}$, $T_J = 125^{\circ}\text{C}$) ($i_F = 15 \text{ Amps}$, $T_J = 125^{\circ}\text{C}$) ($i_F = 15 \text{ Amps}$, $T_J = 25^{\circ}\text{C}$)	V _F	0.57 0.72 0.84	\
Maximum Instantaneous Reverse Current (Note 3) (Rated dc Voltage, $T_J = 125^{\circ}C$) (Rated dc Voltage, $T_J = 25^{\circ}C$)	i _R	15 0.1	mA

^{2.} When mounted using minimum recommended pad size on FR-4 board. 3. Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%.

^{1.} The heat generated must be less than the thermal conductivity from Junction–to–Ambient: $dP_D/dT_J < 1/R_{\theta JA}$.

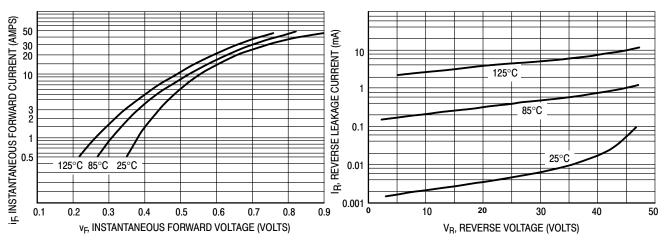


Figure 1. Typical Forward Voltage, Per Leg

Figure 2. Typical Reverse Current, Per Leg

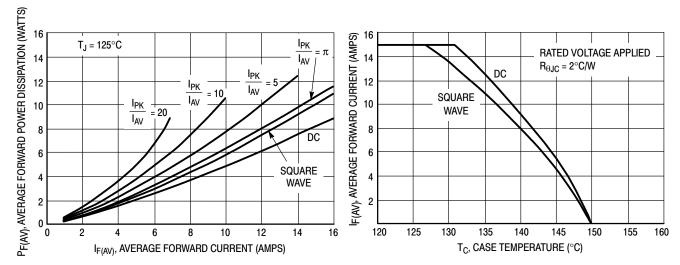


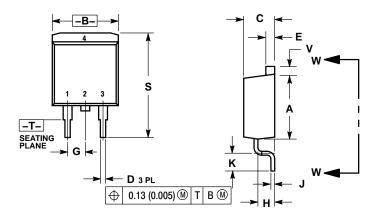
Figure 3. Typical Forward Power Dissipation

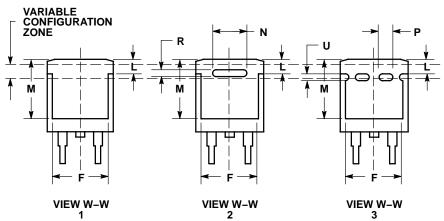
Figure 4. Current Derating, Case

PACKAGE DIMENSIONS

D²PAK

CASE 418B-04 **ISSUE J**



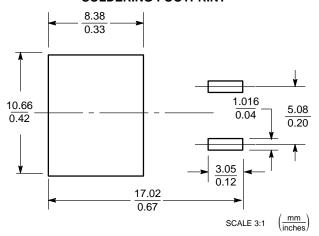


- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. 418B-01 THRU 418B-03 OBSOLETE, NEW STANDARD 418B-04.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.340	0.380	8.64	9.65
В	0.380	0.405	9.65	10.29
С	0.160	0.190	4.06	4.83
D	0.020	0.035	0.51	0.89
E	0.045	0.055	1.14	1.40
F	0.310	0.350	7.87	8.89
G	0.100 BSC		2.54 BSC	
Н	0.080	0.110	2.03	2.79
J	0.018	0.025	0.46	0.64
K	0.090	0.110	2.29	2.79
L	0.052	0.072	1.32	1.83
M	0.280	0.320	7.11	8.13
N	0.197 REF		5.00 REF	
Р	0.079 REF		2.00 REF	
R	0.039 REF		0.99 REF	
S	0.575	0.625	14.60	15.88
V	0.045	0.055	1.14	1.40

- STYLE 3: PIN 1. ANODE 2. CATHODE 3. ANODE 4. CATHODE

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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